

3Northway Lane North Latham, New York 12110.

Tollfree:1.800.984.5337 Phone:1.518.956.2980 Fax:1.518.785.4725

Http://www.marktechopto.com

SPECIFICATION

PART NO.: MT0380-UV-A

5.0mm ROUND LED LAMP

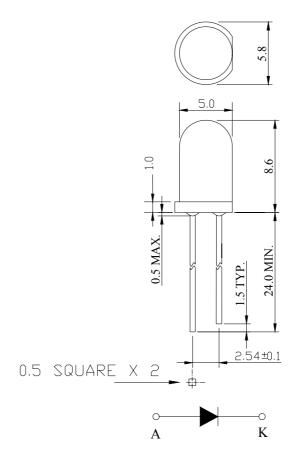






Description

This purple lamp is made with InGaN chip and water clear epoxy resin.



Notes:

- 1. All dimensions are in mm.
- 2. Tolerance is \pm 0.25mm unless otherwise noted.

Description

Part No.	LED Chip			
	Material	Emitting Color	Lens Color	
O V25: 2/WX/C'************************************	""" "K nGaN	Purple	Water Clear	

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Absolute Maximum Ratings at Ta=25

Parameter	Symbol	Rating	Unit
Power Dissipation	PD	120	mW
Reverse Voltage	VR	5	V
D.C. Forward Current	If	30	mA
Reverse (Leakage) Current	Ir	50	μA
Peak Current(1/10Duty Cycle,0.1ms Pulse Width.)	If(Peak)	100	mA
Operating Temperature Range	Topr	-25 to +85	
Storage Temperature Range	Tstg	-40 to +100	
Soldering Temperature(1.6mm from body)	Tsol	Dip Soldering : 260°C for 5 sec. Hand Soldering : 350°C for 3 sec.	
Electrostatic discharge	ESD	6000	V

Electrical and Optical Characteristics:

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Luminous Intensity	Iv	If=20mA	20.0	40.0		mcd
Forward Voltage	Vf	If=20mA		3.2	4.0	V
Peak Wavelength	λр	If=20mA		400		nm
Reverse (Leakage) Current	Ir	Vr=5V			50	μΑ
Viewing Angle	2 1/2	If=20mA		30		deg
Spectrum Line Halfwidth	Δλ	If=20mA		15		nm

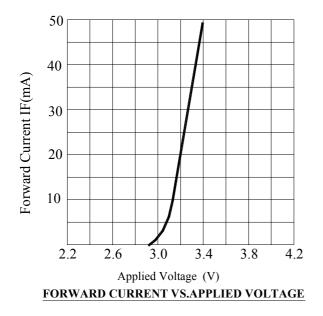
Notes:1. The datas tested by IS tester.

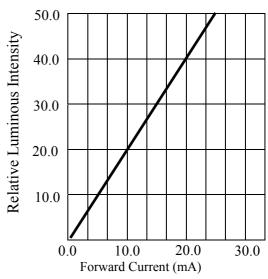
2. Customer's special requirements are also welcome.

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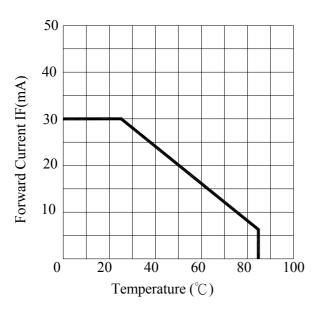


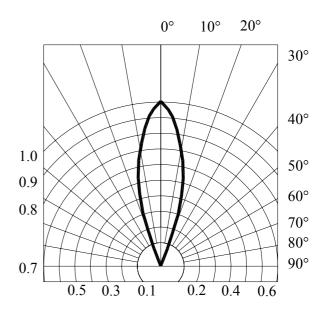
Typical Electrical / Optical Characteristics Curves:





FORWARD CURRENT VS. LUMINOUS INTENSITY





FORWARD CURRENT VS. AMBIENT TEMPERATURE

RADIATION DIAGRAM

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MT0380-UV-A

5.0mm ROUND LED

Precautions:

TAKE NOTE OF THE FOLLOWING IN USE OF LED

1. Temperature in use

Since the light generated inside the LED needs to be emitted to outside efficiently, a resin with high light transparency is used; therefore, additives to improve the heat resistance or moisture resistance (silica gel, etc) which are used for semiconductor products such as transistors cannot be added to the resin.

Consequently, the heat resistant ability of the resin used for LED is usually low; therefore, please be careful on the following during use.

Avoid applying external force, stress, and excessive vibration to the resins and terminals at high temperature. The glass transition temperature of epoxy resin used for the LED is approximately 120-130.

At a temperature exceeding this limit, the coefficient of liner expansion of the resin doubles or more compared to that at normal temperature and the resin is softened.

If external force or stress is applied at that time, it may cause a wire rupture.

2. Soldering

Please be careful on the following at soldering.

After soldering, avoided applying external force, stress, and excessive vibration until the products go to cooling process (normal temperature), <Same for products with terminal leads>

(1) Soldering measurements:

Distance between melted solder side to bottom of resin shall be 1.6mm or longer.

(2) Dip soldering:

Pre-heat: 90 max. (Backside of PCB), Within 60 seconds.

Solder bath: 260±5 (Solder temperature), Within 5 seconds.

(3) Hand soldering: 350 max. (Temperature of soldering iron tip), Within 3 seconds.

3. Insertion

Pitch of the LED leads and pitch of mounting holes need to be same.

4. Others

Since the heat resistant ability of the LED resin is low, SMD components are used on the same PCB, please mount the LED after adhesive baking process for SMD components. In case adhesive baking is done after LED lamp insertion due to a production process reason, make sure not to apply external force, stress, and excessive vibration to the LED and follow the conditions below.

Baking temperature: 120 max. Baking time: Within 60 seconds.

If soldering is done sequentially after the adhesive baking, please perform the soldering after cooling down the LED to normal temperature.

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V CATORION

- 1. LEDs emit very strong UV radiation during operation.
- 2. Don't look directly into the LED light when in operation as UV radiation can harm your eyes.
- 3. To prevent even inadequate exposure, wear protective eyewear.
- 4. If LEDs are embedded in devices, please indicate warning labels against the UV LED used.
- 5. Avoid prolonged exposure to skin or other tissue during operation.
- 6. Keep out of reach of children.
- 7. Take appropriate precautions around pets and other living organisms to avoid UV exposure.
- 8. Specification and dimension are subject to change without notice.

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